DELIVERY SPECIFICATION

SPEC. No. A-Glue-e D A T E : Jun., 2022

То

Non-Controlled Copy

CUSTOMER'S PRODUCT NAME	TDK PRODUCT NAME MULTILAYER CERAMIC CHIP CAPACITORS (Conductive glue) Bulk and Tape packaging [RoHS compliant] CGA2, CGA3, CGA4, CGA5, CGA6 Type
	C0G,NP0,X7R,X8R Characteristics

Please return this specification to TDK representatives with your signature. If orders are placed without returned specification, please allow us to judge that specification is accepted by your side.

RECEIPT CONFIRMATION

DATE:	YEAR	MONTH	DAY

Test conditions in this specification based on AEC-Q200 for automotive application.

TDK Corporation	
Sales	Engineering
Electronic Components	Electronic Components Business Company
Sales & Marketing Group	Ceramic Capacitors Business Group

APPROVED	Person in charge		APPROVED	CHECKED	Person in charge

SCOPE

This delivery specification shall be applied to Multilayer ceramic chip capacitors to be delivered to

PRODUCTION PLACES

Production places defined in this specification shall be TDK Corporation, TDK(Suzhou)Co.,Ltd and TDK Components U.S.A.,Inc.

PRODUCT NAME

The name of the product to be defined in this specifications shall be $\underline{CGA} \otimes \underline{OOO} \triangle \Delta \Box \Box \Box \times \otimes \underline{ \times \times \times B}$.

REFERENCE STANDARD

JIS C 5101-1:2010	Fixed capacitors for use in electronic equipment-Part 1: Generic specification
C 5101-21 : 2014	Fixed capacitors for use in electronic equipment-Part21 : Sectional specification
	: Fixed surface mount multilayer capacitors of ceramic dielectric, Class1
C 5101-22 : 2014	Fixed capacitors for use in electronic equipment-Part22 : Sectional specification
	: Fixed surface mount multilayer capacitors of ceramic dielectric, Class 2
C 0806-3:2014	Packaging of components for automatic handling - Part 3: Packaging of
	surface mount components on continuous tapes
JEITA RCR-2335 C 2014	Safety application guide for fixed ceramic capacitors for use in electronic
	equipment

COONTENTS

- 1. CODE CONSTRUCTION
- 2. COMBINATION OF RATED CAPACITANCE AND TOLERANCE
- 3. OPERATING TEMPERATURE RANGE
- 4. STORING CONDITION AND TERM
- 5. CAUTION FOR CONDUCTIVE GLUE MOUNTING PRODUCTS
- 6. INDUSTRIAL WASTE DISPOSAL
- 7. PERFORMANCE
- 8. INSIDE STRUCTURE AND MATERIAL
- 9. PACKAGING
- 10. CAUTION
- 11. TAPE PACKAGING SPECIFICATION

<EXPLANATORY NOTE>

When the mistrust in the spec arises, this specification is given priority. And it will be confirmed by written spec change after conference of both posts involved.

This specification warrants the quality of the ceramic chip capacitor. Capacitors should be evaluated or confirmed a state of mounted on your product.

If the use of the capacitors goes beyond the bounds of this specification, we can not afford to guarantee.

Division	Date	SPEC. No.
Ceramic Capacitors Business Group	June, 2022	A-Glue-e

1. CODE CONSTRUCTION

(Example)	CGA	3	E	2	X8R	<u>1 H</u>	103	K	<u> </u>	<u> </u>	
	(1)	(2)	(3)	(4)	(5)	(6)	(7)	(8)	(9)	(10)	
(1) Series							Sym	npol		Series	
							CC	6A	For aut	omotive app	lication
(2) Case siz	е						Te	rminal	electroc	le	
			L	G	\rightarrow	B	< W				
	Т Т _1 _1		electro						-		
				Cera	amic diele	ectric					

Case size	Case size	Dimensions (Unit : mm)				
Symbol	(EIA style)	L	W	Т	В	G
2	CGA2 (CC0402)	1.00±0.15	0.50±0.10	0.50±0.10	0.10 min.	0.30 min.
3	CGA3 (CC0603)	1.60±0.15	0.80±0.15	0.80±0.15	0.20 min.	0.30 min.
				0.60±0.15		
	CGA4	2.00±0.25	1.25±0.25	0.85±0.15	0.20 min.	0.50 min.
4	(CC0805)			1.25±0.25		
		$2.00 {+0.35 \\ -0.25}$	$1.25^{+0.30}_{-0.25}$	$1.25 \substack{+0.30 \\ -0.25}$		
				0.60±0.15		
	CGA5	CGA5 (CC1206) 3.20 ^{+0.30} -0.10	$1.60 \substack{+0.30 \\ -0.10}$	0.85±0.15	0.20 min.	1.00 min.
5	$\begin{array}{c} 5 \\ (CC1206) \\ \end{array} \begin{array}{c} 3.20 \\ -0.10 \\ \end{array}$			1.15±0.15		
				$1.60 \substack{+0.30 \\ -0.10}$		
	0040			1.60±0.20		
6	6 CGA6 (CC1210)	3 7010 /6	2.50±0.30	2.00±0.20	0.20 min.	
				2.50±0.30		

*As for each item, please refer to detail page on TDK web.

(3) Thickness

Symbol	Dimension(mm)	
В	0.50	
С	0.60	
Е	0.80	
F	0.85	
Н	1.15	

Dimension(mm)
1.25
1.60
2.00
2.50

(4) Voltage condition in the life test
--

* Details are shown in table1 No.13 at 7.PERFORMANCE.

Condition
Rated Voltage
Rated Voltage x 2
Rated Voltage x 1.5

(5) Temperature Characteristics

* Details are shown in table 1 No.6 and No.7 at 7.PERFORMANCE.

(6) Rated Voltage

Symbol	Rated Voltage
2 A	DC 100 V
1 H	DC 50 V
1 V	DC 35 V
1 E	DC 25 V
1 C	DC 16 V
0 J	DC 6.3 V
	2 A 1 H 1 V 1 E 1 C

(7) Rated Capacitance Stated in three digits and in units of pico farads (pF)	(Example)	Symbol	Rated Capacitance
The first and Second digits identify the first and		2R2	2.2 pF
second significant figures of the capacitance, the third digit identifies the multiplier.		106	10,000,000 pF
R is designated for a decimal point.	-		

- (8) Capacitance tolerance
 - * M tolerance shall be standard for over 10uF.

Symbol	Tolerance	Capacitance
С	± 0.25 pF	10pE and under
D	±0.5 pF	10pF and under
J	± 5%	
К	± 10 %	Over 10pF
*M	± 20 %	

(9) Packaging	Symbol	Packaging
	В	Bulk
	Т	Taping

(10) TDK internal code

B : For conductive glue mounting

⁻ These TDK internal codes are subject to change without notice.

2. COMBINATION OF RATED CAPACITANCE AND TOLERANCE

Class	Temperature Characteristics	Capacitar	ce tolerance	Rated capacitance
		10pF and	C (±0.25pF)	1, 1.5, 2, 2.2, 3, 3.3, 4, 4.7, 5
1	COG NP0	under	D (±0.5pF)	6, 6.8, 7, 8, 9, 10
		Over 10pF	J (± 5 %) K (± 10 %)	E – 12 series
2	X7R X8R		: 10 %) : 20 %)	E – 6 series

Capacitance Step in E series

E series		Capacitance Step										
E- 6	1.	0	1.	.5	2.2		2.2 3.3		3.3 4.7		6.8	
E-12	1.0	1.2	1.5	1.8	2.2	2.7	3.3	3.9	4.7	5.6	6.8	8.2

3. OPERATING TEMPERATURE RANGE

T.C.	Min. operating Temperature	Max. operating Temperature	Reference Temperature
C0G	-55°C	125°C	25°C
NP0	-55°C	150°C	25°C
X7R	-55°C	125°C	25°C
X8R	-55°C	150°C	25°C

4. STORING CONDITION AND TERM

Storing temperature	Storing humidity	Storing term
5~40°C	20~70%RH	Within 6 months upon receipt.

5. INDUSTRIAL WASTE DISPOSAL

Dispose this product as industrial waste in accordance with the Industrial Waste Law.

6. CAUTION FOR CONDUCTIVE GLUE MOUNTING PRODUCTS

This product is to be mounted by glue including Ag (Silver) as a conductive material. To avoid electromigration of Ag and failures caused by corrosive gas, chip capacitors on P.C boards should be protected by moisture proof-sealing, such as silicon or equivalent, and/or a sealed package.

7. PERFORMANCE

Table 1

	-				Table 1				
No.	Item	n		Pe	rformance	Test or insp	pection me	thod	
1	External App	External Appearance N			ich may affect	Inspect with magnif	ying glass	(3×)	
2	Insulation Re	esistance	(As for th voltage 1	e cap 6V D	500MΩ·µF min. acitors of rated C and lower, n.,) whichever smaller.	Measuing voltage : Rated voltage Voltage application time : 60s.			
3	Voltage Proo	Voltage Proof Withstand test voltage without Class 1 : 3 times of ra insulation breakdown or other Class 2 : 2.5 times of ra damage. Voltage application time				of rated vol time : 1s.	ltage		
4	Capacitance		Within th	e spe	cified tolerance.	《Class 1》			
						Capacitance	Measuring frequency	Measuring voltage	
					1000pF and under	1MHz±10%			
					Over 1000pF	1kHz±10%	0.5 ~ 5 Vrms.		
						《Class 2》		•	
						Measuring frequenc	y Measur	ing voltage	
						1kHz±10%	1.0±0.2Vrms		
						As for the capacitor DC, 0.5Vrms is app		voltage 6.3V	
5	Q	Class1	Please re web.	efer to	detail page on TDK	See No.4 in this tab condition.	le for meas	suring	
	Dissipation Factor	Class2							
6 Temperature Characteristics of Capacitance (Class1)		Characteristics of CapacitanceT.C.Temperature Coefficient (ppm/°C)				Temperature coeffic based on values at temperature.	25°C and 8	35°C	
		NP0 0 ± 30				Measuring temperature below 25°C shall be -10°C and -25°C.			
			CapacitanceWithin $\pm 0.2\%$ ordrift $\pm 0.05pF$, whichever larger.						

(continued)

(C	ontinued)		1		1			
No.	1	tem	Perf	ormance	Т	est or inspection method		
7	Temperatu Character	istics	Capacitano	ce Change (%)	Capacitance shall be measured by the steps shown in the following table after			
	of Capacit (Class2)	ance	No volt	age applied	thermal equilibrium is obtained for each step.			
			X7F	R : ± 15	ΔC be cal	culated ref. STEP3 reading		
			X8F	R : ± 15	Step	Temperature(°C)		
					1	Reference temp. ± 2		
					2	Min. operating temp. ± 3		
					3	Reference temp. ± 2		
					4	Max. operating temp. ± 2		
					As for Min./ Max. operating temp. and Reference temp., please refer to "3.OPERATING TEMPERATURE RANGE" As for measuring voltage, please contact with our sales representative.			
8	Robustnes	bustness of No sign of termination coming off, minations breakage of ceramic, or other abnormal signs.				e capacitors on an Alumina shown in Appendix 1 with re glue. ushing force gradually at the a specimen in a horizontal of P.C.board. force : 5N plied for CGA2 type.) me : 10±1s. Pushing force Alumina substrate		
9	Vibration	External appearance	No mechanical	damage.		orce : 5G max. y : 10~2,000Hz		
		Capacitance	Characteristics	Change from the value before test	Reciproca	ating sweep time : 20 min. 2 cycles in each 3 mutually		
			Class1 C0G NP0	± 2.5% or ± 0.25pF, whichever larger.		erpendicular directions.		
			Class2 X7R X8R	± 7.5 %	substrate	e capacitors on an Alumina shown in Appendix 1 with re glue before testing.		
		Q (Class1)	Meet the initial	spec.		- <u>,</u>		
		D.F. (Class2)	Meet the initial	spec.				

(continued)

(00	ntinuea)		r			- I				
No.	lte	em	Performance				Test or inspection me	ethod		
10	Temperature cycle	External appearance Capacitance	No mech	anical	damage.	Expose the capacitors in the condition step1 through step 4 listed in the following table.				
		Capacitanico	Charact	eristics	Change from the value before test	Temp.	cycle: 1,000 cycles			
						Step	Temperature(°C)	Time(min.)		
			Class1	C0G NP0	Please contact with our sales	1	Min. operating temp. ±3	30 ± 3		
			Class2	X7R	representative.	2	Reference Temp.	2 ~ 5		
				X8R		3	Max. operating temp. ±2	30 ± 2		
		Q	Meet the	initial	spec.	4	Reference Temp.	2~5		
		(Class1)				As for	Min./ Max. operating	temp. and		
		D.F. (Class2)	Meet the	initial	spec.	Refere	nce temp., please ref RATING TEMPERATU	er to		
		Insulation Resistance	Meet the	initial	spec.	Leave the capacitors in ambient condition for Class 1 : 6~24h Class 2 : 24±2h before measurement				
		Voltage proof	No insula other dar		reakdown or	substra	the capacitors on an ate shown in Appendiz ctive glue before testi	x 1 with		
11	Moisture Resistance	External appearance	No mech	anical	damage.		Test temp. : 40±2°C Test humidity : 90~95%RH			
	(Steady State)	Capacitance	Characteristics Change from the value before test			Test tir	Test time : 500 +24,0h			
			Class1	C0G NP0	Please contact with our sales	Leave the capacitors in ambient condition for Class 1 : 6~24h Class 2 : 24±2h before measureme				
			Class2 X7R X8R		representative.	Mount	Mount the capacitors on an Alumina			
		Q					ate shown in Appendi. ctive glue before testi			
		(Class1)	Capac	itance	Q	Conduc				
				nd over						
			•	nd over 30pF	275+5/2×C min.					
				10pF	200+10×C min.					
		D F	C : Rate	d capa	citance (pF)					
		D.F. (Class2)	200% of initial spec. max.							
		Insulation Resistance	(As for th voltage 1	ne capa 6V DC	MΩ·µF min. acitors of rated c and lower,) whichever					

(continued)

No.	lt	em		Perfo	ormance	Test or inspection method	
12	Moisture Resistance	External appearance	No mech	anical	damage.	Test temp. : 85±2°C Test humidity : 85%RH	
		Capacitance	Charact	eristics	Change from the value before test	Applied voltage : Rated voltage Test time : 1,000 +48,0h	
			Class1	COG NP0	Please contact with our sales	Charge/discharge current : 50mA or lower	
			Class2	X7R X8R	representative.	Leave the capacitors in ambient condition for Class 1 : 6~24h	
		Q				Class 2 : 24±2h before measurement.	
		(Class1)	Capac	itance	Q		
			30pF ar	nd over	200 min.	Mount the capacitors on an Alumina substrate shown in Appendix 1 with	
			Under C : Rate		100+10/3×C min. citance (pF)	conductive glue before testing.	
		D.F. (Class2)	200% of	initial s	pec. max.	Initial value setting (only for class 2) Voltage conditioning 《After voltage treat	
		Insulation Resistance	(As for th voltage 1	ie capa 6V DC	D·μF min. acitors of rated and lower, whichever smaller.	the capacitors under testing temperature and voltage for 1 hour, leave the capacitors in ambient condition for 24±2h before measurement. Use this measurement for initial value.	
13	Life	External appearance	No mech	anical	damage.	Test temp. : Maximum operating temperature±2°C Applied voltage : Please contact with our sales representative. Test time : 1,000 +48,0h	
		Capacitance	Charact	eristics	Change from the value before test		
			Class1	COG NP0	Please contact with our sales	Charge/discharge current : 50mA or lower	
			Class2	X7R X8R	representative.	Leave the capacitors in ambient condition for	
		Q			0	Class 1 : 6~24h Class 2 : 24±2h before measurement.	
		(Class1)		itance	Q		
			10pF ai		350 min. 275+5/2×C min.	Mount the capacitors on an Alumina substrate shown in Appendix 1 with	
			under	-		conductive glue before testing.	
			Under C : Rate	•	200+10×C min. citance (pF)	Initial value setting (only for class 2)	
		D.F. (Class2)	200% of	initial s	pec. max.	Voltage conditioning 《After voltage treat the capacitors under testing temperature and voltage for 1 hour,》 leave the	
		Insulation Resistance	(As for th voltage 1	ie capa 6V DC	MΩ·µF min. acitors of rated and lower, whichever	capacitors in ambient condition for 24±2h before measurement. Use this measurement for initial value.	

*As for the initial measurement of capacitors (Class2) on number 7,9,10 and 11 leave capacitors at 150 0,-10°C for 1 hour and measure the value after leaving capacitors for 24±2h in ambient condition.



(Unit : mm)

Symbol	Dimensions			
Case size	а	b	С	
CGA2 (CC0402)	0.5	1.4	0.5	
CGA3 (CC0603)	0.7	2.2	1.2	
CGA4 (CC0805)	0.7	2.7	1.75	
CGA5 (CC1206)	1.7	3.9	2.05	
CGA6 (CC1210)	1.8	4.4	3.0	

1. Material : Alumina substrate

2. Thickness : 0.8mm

AgPt
Glass resist

3. Caution for mounting with conductive glue (Refer to the page 13.)

8. INSIDE STRUCTURE AND MATERIAL



No	NAME	MATERIAL			
No.	NAME	Class1	Class2		
1	Dielectric	CaZrO₃	BaTiO₃		
2	Electrode	Nickel (Ni)			
3	Termination	Copper (Cu)			
4	remination	AgPdCu			

9. PACKAGING

Packaging shall be done to protect the components from the damage during transportation and storing, and a label which has the following information shall be attached.

- 9.1 Each plastic bag for bulk packaging contains 1000pcs. And the minimum quantity for Bulk packaging is 1000pcs.
- 9.2 Tape packaging is as per 11. TAPE PACKAGING SPECIFICATION.
 - * CGA2 [CC0402] type is applicable to tape packaging only.
 - 1) Inspection No.
 - 2) TDK P/N
 - 3) Customer's P/N
 - 4) Quantity

*Composition of Inspection No.

Example
$$\frac{F}{(a)} \frac{2}{(b)} \frac{A}{(c)} - \frac{2}{(c)} \frac{3}{(c)} - \frac{0}{(c)} \frac{0}{(c)} \frac{1}{(c)}$$

- (a) Line code
- (b) Last digit of the year
- (c) Month and A for January and B for February and so on. (Skip I)
- (d) Inspection Date of the month.
- (e) Serial No. of the day

*Composition of new Inspection No.

(Implemented on and after May 1, 2019 in sequence)

Example



- (a) Prefix
- (b) Line code
- (c) Last digit of the year
- (d) Month and A for January and B for February and so on. (Skip I)
- (e) Inspection Date of the month.
- (f) Serial No. of the day(00 ~ ZZ)
- (g) Suffix(00 ~ ZZ)
- * It was shifted to the new inspection No. on and after May 2019, but the implementation timing may be different depending on shipment bases.

Until the shift is completed, either current or new composition of inspection No. will be applied.

10. CAUTION

		1
No.	Process	Condition
1	Operating Condition (Storage, Use, Transportation)	1-1. Storage, Use The capacitors must be stored in an ambient temperature of 5 to 40°C with a relative humidity of 20 to 70%RH. JIS C 60721-3-1 Class 1K2 should be followed fo the other climatic conditions.
		 High temperature and humidity environment may affect a capacitor's performance. Therefore, SMD capacitors shall be used within 6 months. For capacitors with terminal electrodes consisting of silver or silver-palladium which tend to become oxidized or sulfurized, use as soon as possible, such as within one month after opening the bag.
		 2) During storage, keep the minimum packaging unit in its original packaging without opening it. Do not deviate from the above temperature and humidity conditions even for a short term.
		 Corrosive gasses in the air or atmosphere may result in deterioration of the reliability. Do not store capacitors where they will be exposed to corrosive gas (e.g., hydrogen sulfide, sulfur dioxide, chlorine ammonia etc.)
		 4) Electrical performance may deteriorate due to photochemical change in the terminal electrode if stored in direct sunlight, or due to condensation from rapid changes in humidity. The capacitors especially which use resin material must be operated and stored in an environment free of dew condensation, as moisture absorption due to condensation may affect the performance.
		5) Refer to JIS C 60721-3-1, class 1K2 for other climate conditions.
		 1-2. Handling in transportation In case of the transportation of the capacitors, the performance of the capacitors may be deteriorated depending on the transportation condition. (Refer to JEITA RCR-2335C 9.2 Handling in transportation)
2	Circuit design	2-1. Operating temperature
-		 Upper category temperature (maximum operating temperature) is specified. It is necessary to select a capacitor whose rated temperature us higher than the operating temperature. Also, it is necessary to consider the temperature distribution in the equipment and seasonal temperature variation.
		 2) Surface temperature including self heating should be below maximum operating temperature. Due to dielectric loss, capacitors will heat itself when AC is applied due to ESR. Especially at high frequencies, please be careful that the heat might be so extreme. Also, even if the surface temperature of the capacitor includes self-heating and is the maximum operating temperature or lower, excessive heating of the capacitor due to self-heating may cause deterioration of the characteristics and reliability of the capacitor. The self-heating temperature rise of the capacitor changes depending on the difference in heat radiation due to the mounting method to the device, the ambient temperature, the cooling method of the device and circuit board material and the design, etc. The load should be contained so that the self-heating temperature rise of the capacitor body in a natural convection environment at an ambient temperature of 25°C remain below 20°C.
		When using in a high-frequency circuit or a circuit in which a capacitor generates heat, such as when a high-frequency ripple current flows, pay attention to the above precautions. (Note that accurate measurement may not be possible with self- heating measurement when the equipment applies cooling other than natural convection such as a cooling fan.)

No.	Process	Condition					
2	Circuit design	 The electrical characteristics of the capacitors will vary depending on the temperature. The capacitors should be selected and designed in taking the temperature into consideration. 					
		2-2. When overvoltage is applied					
		Applying overvoltage to a capacitor may cause dielectric breakdown and result in a short circuit. The duration until dielectric breakdown depends on the applied voltage and the ambient temperature.					
		2-3. Operating voltage					
		 Operating voltage across the terminals should be below the rated voltage. When AC and DC are super imposed, V_{0-P} must be below the rated voltage. — (1) and (2) 					
		AC or pulse with overshooting, V_{P-P} must be below the rated voltage. — (3), (4) and (5)					
		When the voltage is started to apply to the circuit or it is stopped applying, the irregular voltage may be generated for a transit period because of resonance or switching. Be sure to use the capacitors within rated voltage containing these Irregular voltage.					
		Voltage (1) DC voltage (2) DC+AC voltage (3) AC voltage					
		Positional Measurement (Rated voltage)					
		Voltage (4) Pulse voltage (A) (5) Pulse voltage (B)					
		Positional Measurement (Rated voltage)					
		 Even below the rated voltage, if repetitive high frequency AC or pulse is applied, the reliability of the capacitors may be reduced. 					
		 The effective capacitance will vary depending on applied DC and AC voltages. The capacitors should be selected and designed in taking the voltages into consideration. 					
		4) Abnormal voltage (surge voltage, static electricity, pulse voltage, etc.) shall not exceed the rated voltage.					
		5) When capacitors are used in a series connection, it is necessary to add a balancing circuit such as voltage dividing resistors in order to avoid an imbalance in the voltage applied to each capacitor.					
		2-4. Frequency When the capacitors (Class 2) are used in AC and/or pulse voltages, the capacitors may vibrate themselves and generate audible sound.					

No.	Process	Condition					
3	Designing Alumina Substrate	 The amount of glue at the terminations has a direct effect on the reliability of the capacitors. 1) The greater the amount of glue with low thickness of land, the higher risk of elect connection by conductive glue. Design of land and the amount of glue must be considered well. 2) Avoid using common land for multiple terminations and provide individual land for each terminations. 					
4	Mounting	 4-1. Stress from mounting head 1) If the mounting head is adjusted too low, it may induce excessive stress in the chip capacitor to result in cracking. Please take following precautions. 2) Adjust the bottom dead center of the mounting head to reach on the Alumina substrate surface and not press it. 3) Adjust the mounting head pressure to be 1 to 3N of static weight. 4-2. Amount of conductive glue Excessive glue will make a electrical connection under the chip. In sufficient glue may detach the capacitor from the Alumina substrate. Excessive glue in the capacitor from the Alumina substrate. Excessive glue in the capacitor from the Alumina substrate. Excessive glue in the capacitor from the Alumina substrate. Excessive glue in the capacitor from the Alumina substrate. Excessive glue in the capacitor from the Alumina substrate. Excessive glue in the capacitor from the Alumina substrate. Excessive glue in the capacitor from the Alumina substrate. Excessive glue in the capacitor from the Alumina substrate. 					

No.	Process	Condition
5	Coating and molding of the Alumina substrate	 When the Alumina substrate is coated, please verify the quality influence on the product. Please verify carefully that there is no harmful decomposing or reaction gas emission during curing which may damage the chip capacitors. Please verify the curing temperature.
6	Handling of loose chip capacitors	 If dropped the chip capacitors may crack. Once dropped do not use it. Especially, the large case sized chip capacitors are tendency to have cracks easily, so please handle with care.
		Floor
		2) Piling the Alumina substrate after mounting for storage or handling, the corner of the Alumina substrate may hit the chip capacitors of another board to cause crack.
		Crack P.C.board
7	Capacitance aging	The capacitors (Class 2) have aging in the capacitance. They may not be used in precision time constant circuit. In case of the time constant circuit, the evaluation should be done well.
8	Estimated life and estimated failure rate of capacitors	As per the estimated life and the estimated failure rate depend on the temperature and the voltage. This can be calculated by the equation described in JEITA RCR-2335C Annex F (Informative) Calculation of the estimated life time and the estimated failure rate. (Voltage acceleration coefficient : 3 multiplication rule, Temperature acceleration coefficient : 10°C rule) The failure rate can be decreased by reducing the temperature and the voltage but they will not be guaranteed.

No.	Process	Condition
9	Caution during operation of equipment	 A capacitor shall not be touched directly with bare hands during operation in order to avoid electric shock. Electric energy held by the capacitor may be discharged through the human body when touched with a bare hand. Even when the equipment is off, a capacitor may stay charged. The capacitor should be handled after being completely discharged using a resistor.
		2) The terminals of a capacitor shall not be short-circuited by any accidental contact with a conductive object. A capacitor shall not be exposed to a conductive liquid such as an acid or alkali solution. A conductive object or liquid, such as acid and alkali, between the terminals may lead to the breakdown of a capacitor due to short circuit
		 3) Confirm that the environment to which the equipment will be exposed during transportation and operation meets the specified conditions. Do not to use the equipment in the following environments. (1) Environment where a capacitor is spattered with water or oil (2) Environment where a capacitor is exposed to direct sunlight (3) Environment where a capacitor is exposed to Ozone, ultraviolet rays or radiation (4) Environment where a capacitor exposed to corrosive gas(e.g. hydrogen sulfide, sulfur dioxide, chlorine. ammonia gas etc.) (5) Environment where a capacitor exposed to vibration or mechanical shock exceeding the specified limits. (6) Atmosphere change with causes condensation
10	Others	 The product listed in this specification is intended for use in automotive applications under-normal operation and usage conditions. The product is not designed or warranted to meet the requirements of application listed below, whose performance and/or quality requires a more stringent level of safety or reliability, or whose failure, malfunction or defect could cause serious damage to society, person or property. Please understand that we are not responsible for any damage or liability caused by use of the products in any of the applications below or for any other use exceeding the range or conditions set forth in this specification, please contact us. (1) Aerospace/Aviation equipment (2) Transportation equipment (electric trains, ships etc.) (3) Medical equipment (Excepting Pharmaceutical Affairs Law classification Class1, 2) (4) Power-generation control equipment (5) Atomic energy-related equipment
		 (6) Status equipment (7) Transportation control equipment (8) Public information-processing equipment (9) Military equipment (10) Electric heating apparatus, burning equipment (11) Disaster prevention/crime prevention equipment (12) Safety equipment (13) Other applications that are not considered general-purpose applications When designing your equipment even for general-purpose applications, you are kindly requested to take into consideration securing protection circuit/device or providing backup circuits in your equipment. In addition, although the product listed in this specification is intended for use in automotive applications as described above, it is not prohibited to use for general electronic equipment, whose performance and/or quality doesn't require a more stringent level of safety or reliability, or whose failure, malfunction or defect could not cause serious damage to society, person or property. Therefore, the description of this caution will be applied, when the product is used in general electronic equipment under a normal operation and usage conditions.

11. TAPE PACKAGING SPECIFICATION

1. CONSTRUCTION AND DIMENSION OF TAPING

1-1. Dimensions of carrier tape

Dimensions of paper tape shall be according to Appendix 2, 3. Dimensions of plastic tape shall be according to Appendix 4.

1-2. Bulk part and leader of taping



1-3. Dimensions of reel

Dimensions of Ø178 reel shall be according to Appendix 5, 6. Dimensions of Ø330 reel shall be according to Appendix 7, 8.

1-4. Structure of taping



2. CHIP QUANTITY

Please refer to detail page on TDK web.

3. PERFORMANCE SPECIFICATIONS

3-1. Fixing peeling strength (top tape)

0.05N < Peeling strength < 0.7N

<Paper>



<Plastic>



- 3-2. Carrier tape shall be flexible enough to be wound around a minimum radius of 30mm with components in tape.
- 3-3. The missing of components shall be less than 0.1%
- 3-4. Components shall not stick to fixing tape.
- 3-5. When removing the cover tape, there shall not be difficulties by unfitting clearance gap, burrs and crushes of cavities. Also the sprocket holes shall not be covered by absorbing dust into the suction nozzle.

Paper Tape



(Unit	:	mm)
-------	---	-----

Symbol Case size	A	В	С	D	Е	F
CGA2 (CC0402)	(0.65)	(1.15)	8.00 ± 0.30	3.50 ± 0.05	1.75 ± 0.10	2.00 ± 0.05
Symbol Case size	G	н	J	Т	-	
CGA2 (CC0402)	2.00 ± 0.05	4.00 ± 0.10	Ø 1.50 ^{+0.10}	0.60±0.15	-	

() Reference value.

Appendix 3



Symbol Case size	А	В	С	D	E	F
CGA3 (CC0603)	(1.10)	(1.90)				
CGA4 (CC0805)	(1.50)	(2.30)	8.00 ± 0.30	3.50 ± 0.05	1.75 ± 0.10	4.00 ± 0.10
CGA5 (CC1206)	(1.90)	(3.50)				
Symbol Case size	G	Н	J	Т		
CGA3 (CC0603)						
CGA4 (CC0805)	2.00 ± 0.05	4.00 ± 0.10	Ø 1.50 ^{+0.10}	1.20 max.		
CGA5 (CC1206)						

() Reference value.

Plastic Tape



Symbol Case size	A	В	С	D	Е	F
CGA3 (CC0603)	(1.10)	(1.90)				
CGA4 (CC0805)	(1.50)	(2.30)	8.00 ± 0.30	3.50 ± 0.05	1.75 ± 0.10	4.00 ± 0.10
CGA5 (CC1206)	(1.90)	(3.50)	* 12.0 ± 0.30	* 5.50 ± 0.05	1.75 ± 0.10	4.00 ± 0.10
CGA6 (CC1210)	(2.90)	(3.60)				
Symbol Case size	G	Н	J	К	Т	Q
CGA3 (CC0603)				1.50 max.		
CGA4 (CC0805) CGA5	2.00 ± 0.05	4.00 ± 0.10	ø 1.50 ^{+0.10}	2.50 max.	0.60 max.	Ø 0.50 min.
(CC1206) CGA6 (CC1210)				3.40 max.		

() Reference value.

Exceptionally no hole in the cavity is applied. Please inquire if hole in cavity is mandatory.

* Applied to thickness, 2.5mm products.

Dimensions of reel (Material : Polystyrene) CGA2, CGA3, CGA4, CGA5, CGA6



Appendix 6

Dimensions of reel (Material : Polystyrene) CGA6(2.5mm thickness products)



					(0))
Symbol	А	В	С	D	Е	W ₁
Dimension	Ø178 ± 2.0	Ø60 ± 2.0	Ø13 ± 0.5	Ø21 ± 0.8	2.0 ± 0.5	13.0 ± 0.3
Symbol	W ₂	R				
Dimension	17.0 ± 1.4	1.0				

Dimensions of reel (Material : Polystyrene) CGA2, CGA3, CGA4, CGA5, CGA6



Appendix 8

Dimensions of reel (Material : Polystyrene) CGA6(2.5mm thickness products)

